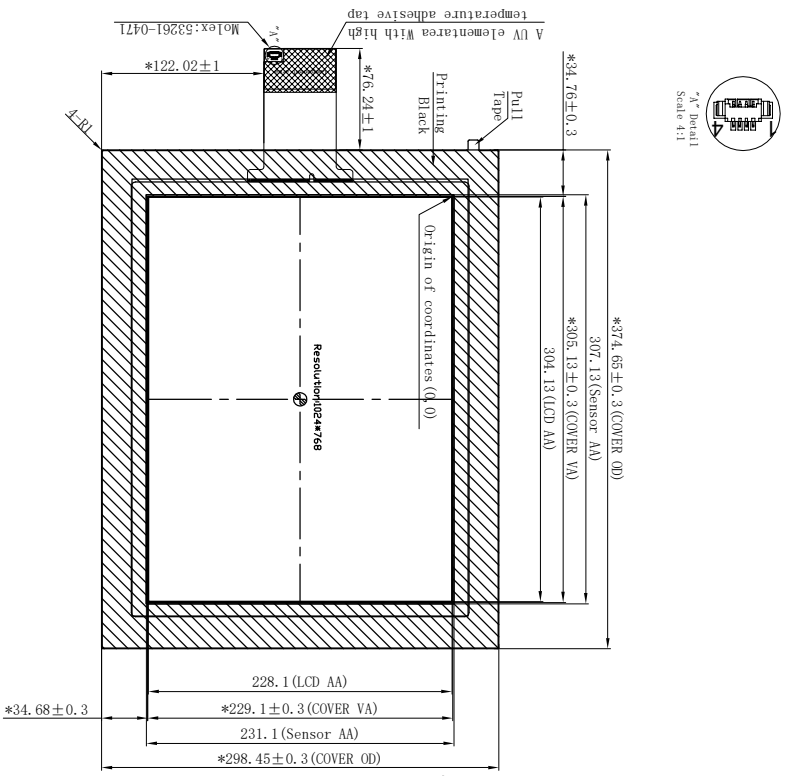


PROPERTY	Requirement
STRUCTURE	G+C
Bonding Type	Optical bonding
TOUCH IC	mx11664T3
NO. OF TOUCH	1 (Disposable gloves)
Coverglass Thickness	4.0mm (Chemical Strengthening AG)
I/O Glass Thickness	1.1mm
Surface Hardness	≥7H
Light Transmittance	85% Min
Operating Temperature	-20~70°C
Storage Temperature	-30~80°C
TP+LCM BRIGHTNESS	320cd/m ² (MIN) 340cd/m ² (TYP)

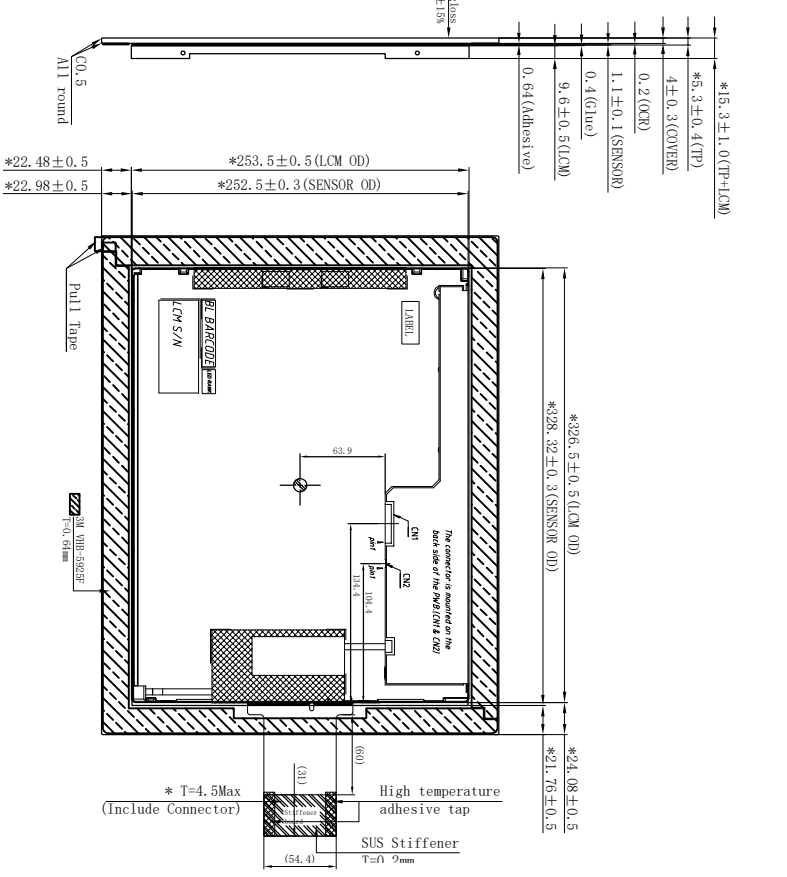
TECHNOLOGY CHARACTERISTICS CTP/LCM

NOTES:
 *: Important dimensions
 TOLERANCE UNLESS: x. x±0.3
 OTHERWISE SPECIFIED: x.xx±0.2
 DIMENSIONS IN MM: ANGULAR: ±1°

ROHS



Front view



Side view

Back view

DRAWN: Yan

CHECKED: Lee

APPROVED: Doppe

CSR APPROVED: Customer No.:

3rd Angle

DATE: 2020.03.19

TITLE: MODULE SPEC.

Product NO: FN150PGRGRLO01A

Project No: TPM8484

Drawing NO: CT0500-V3.0

FANAL ELECTRONICS CO., LTD

VER.	SYMBOL	AMENDMENT	SIGN	DATE	SHEET 1 OF 1
1.0	△	First Issue	Yan	2020.03.19	

THE DRAWING ON THIS PRINT AND INFORMATION THEREON ARE THE PROPERTY OF FANAL AND SHALL NOT BE REPRODUCED OR COPIED IN ANY MANNER WITHOUT WRITTEN PERMISSION OF FANAL.